



MICROCHIP
The Embedded Control Solutions Company®

Product Change Archive

Product Change Notification

[Home](#)

The information below reflects a change that is being implemented.

Notice Date: 07/15/2002
Product Category: Core 12; Core 14
Notification Subject: CCB #368 - 8 and 14 pin Ceramic Windowed DIP

Notification Body:
Projected Ship Date of Revised Device:
July 2002

Description of Change:
Adding 8L and 14L windowed CERDIP (0.300") assembled at Alphatec Semiconductor Packaging (ASP), Thailand
Devices effected are: PIC12C508A, PIC12C509A, PIC12C508, PIC12C509, PIC12CE518, PIC12CE519, PIC12C671, PIC12C672, PIC12CE673, PIC12CE674 and PIC16C505

Impacts to Data Sheet:
NONE

Reason for Change:
To replace 8L and 14L CERAMIC SIDEBRAZE because Semi-alloy who is a single source of piece parts supplier was closed.

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking)
Date code, Traceability code and Country Of Origin shall be "Thailand".